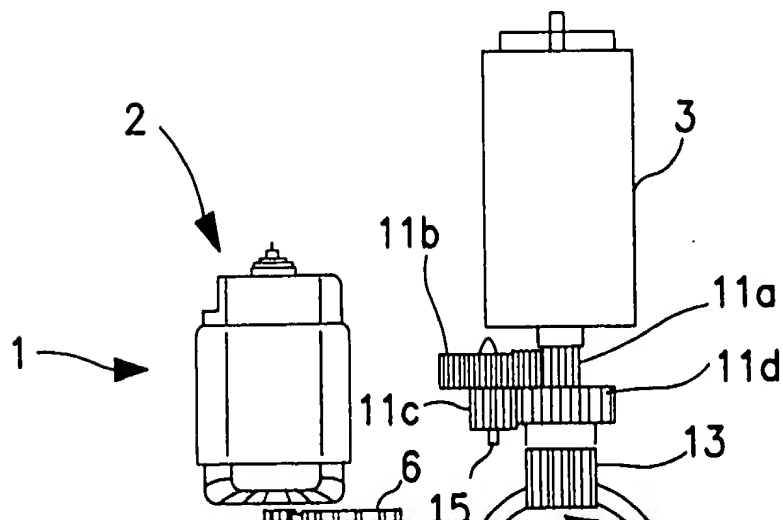


FIG. 1



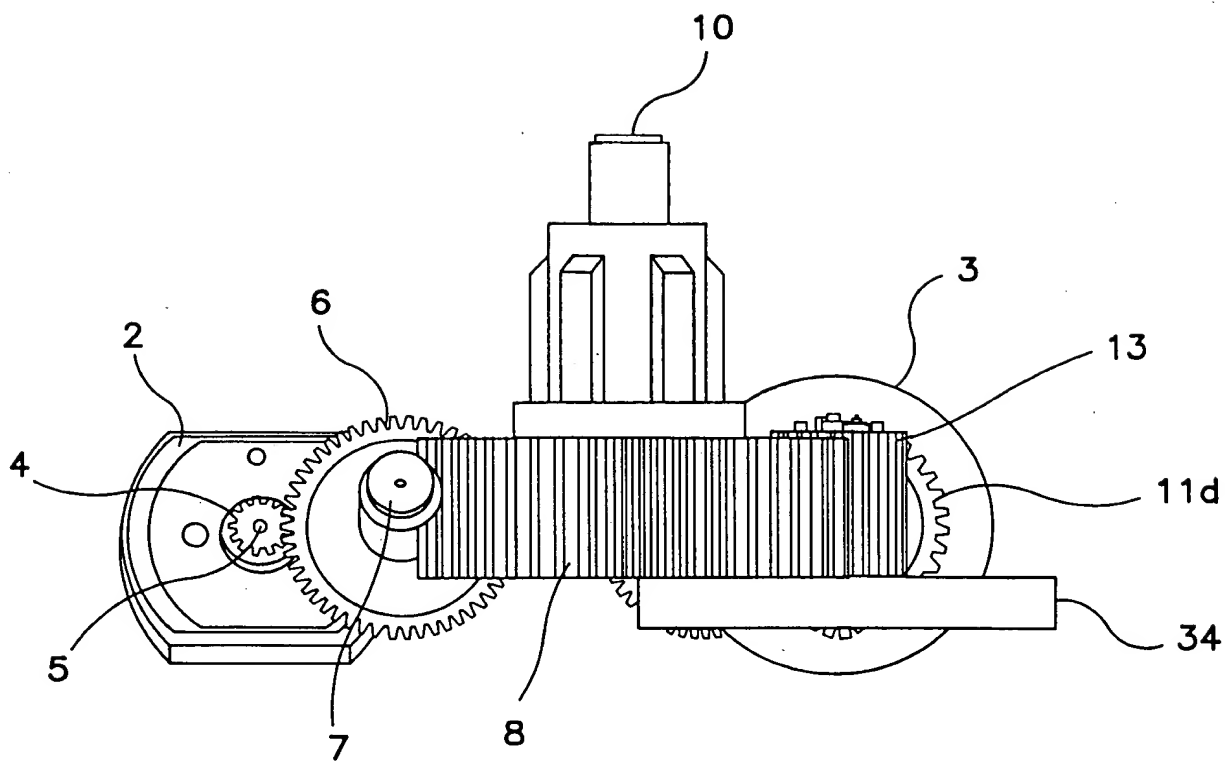


FIG. 3

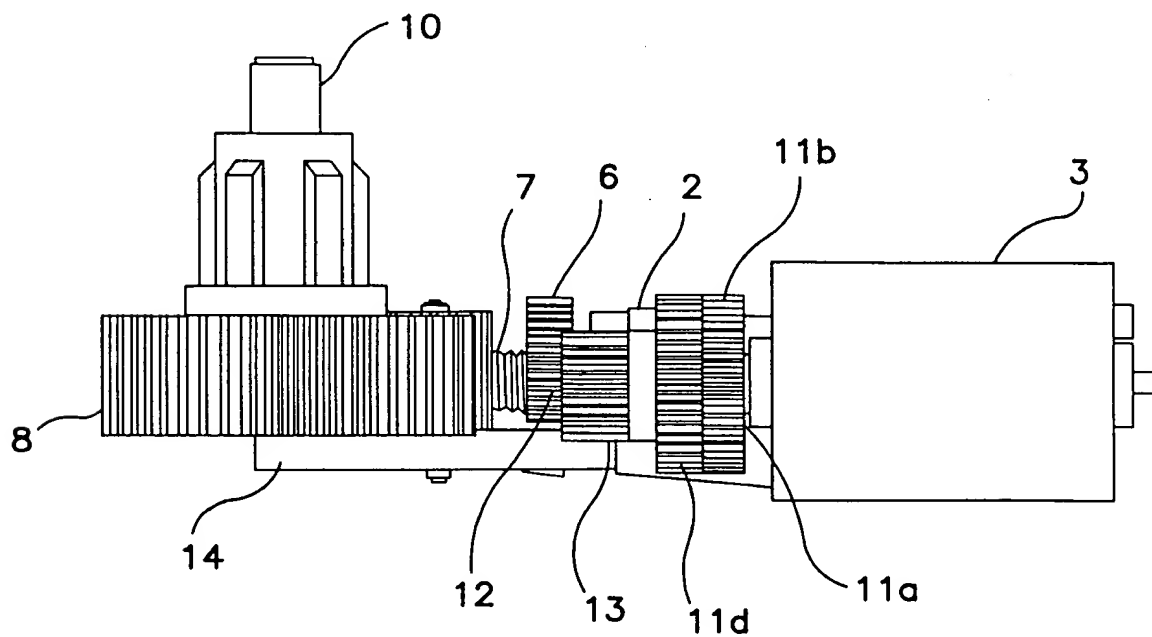


FIG. 4

0976599-050701

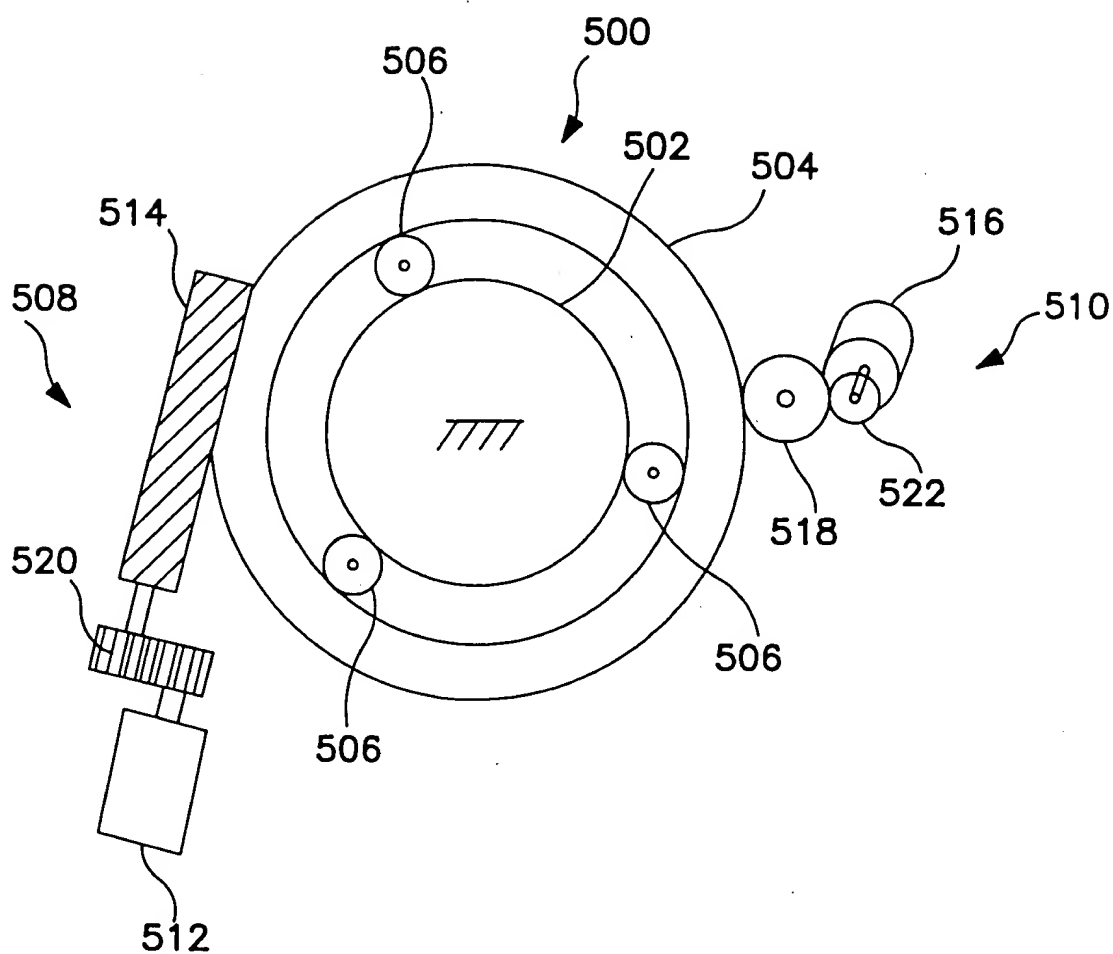


FIG. 5

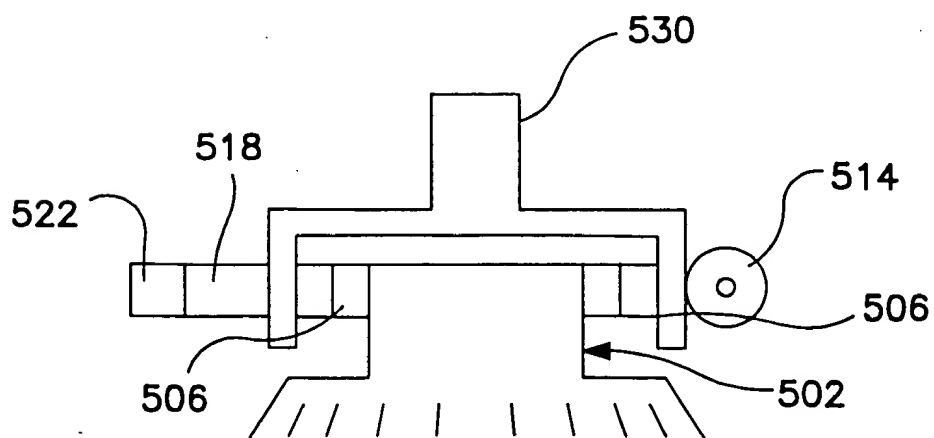


FIG. 6

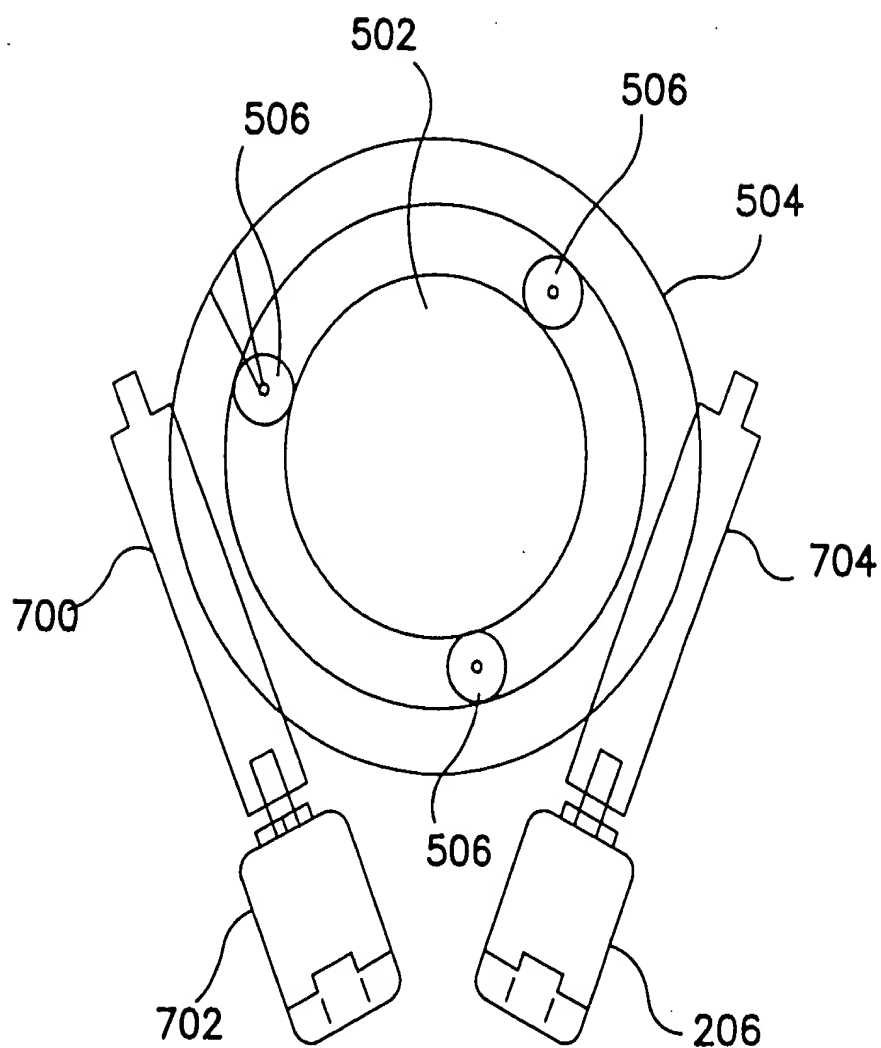


FIG. 7

09765869-050701

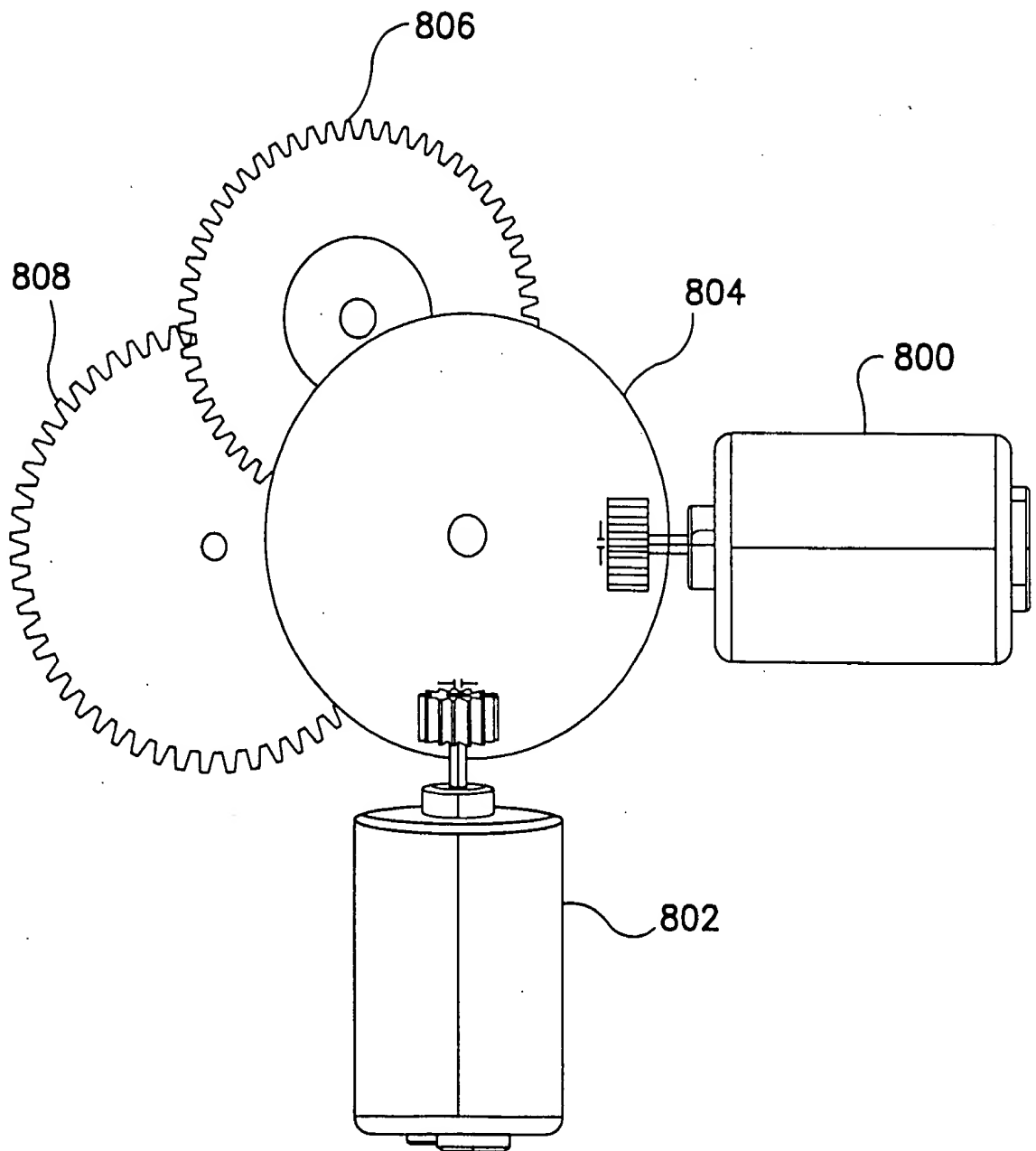


FIG 8

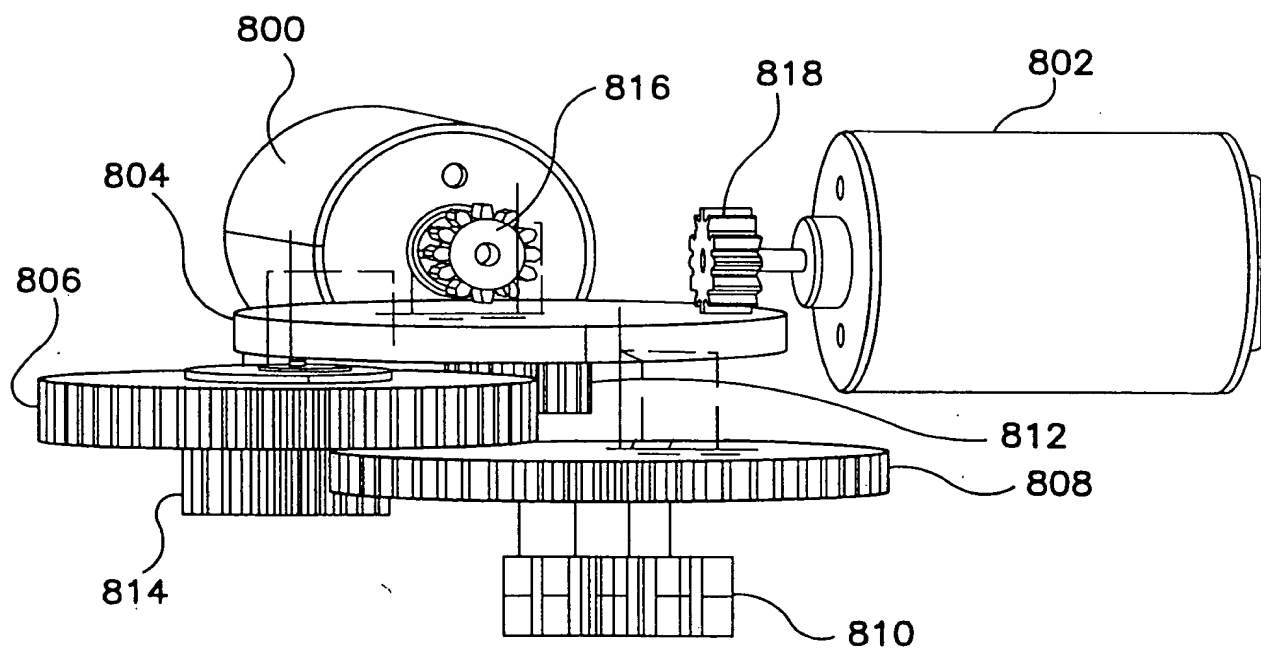


FIG. 9

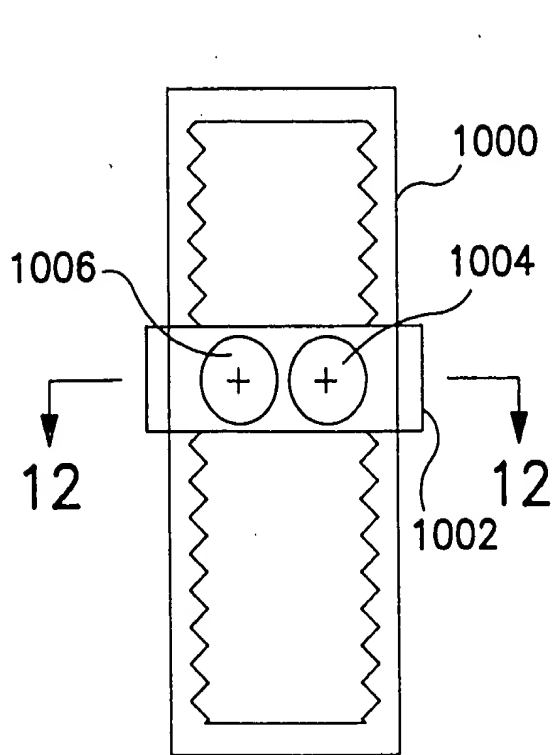


FIG. 10

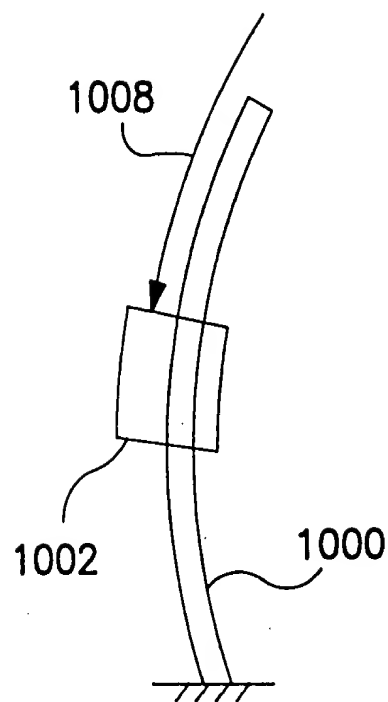


FIG. 11

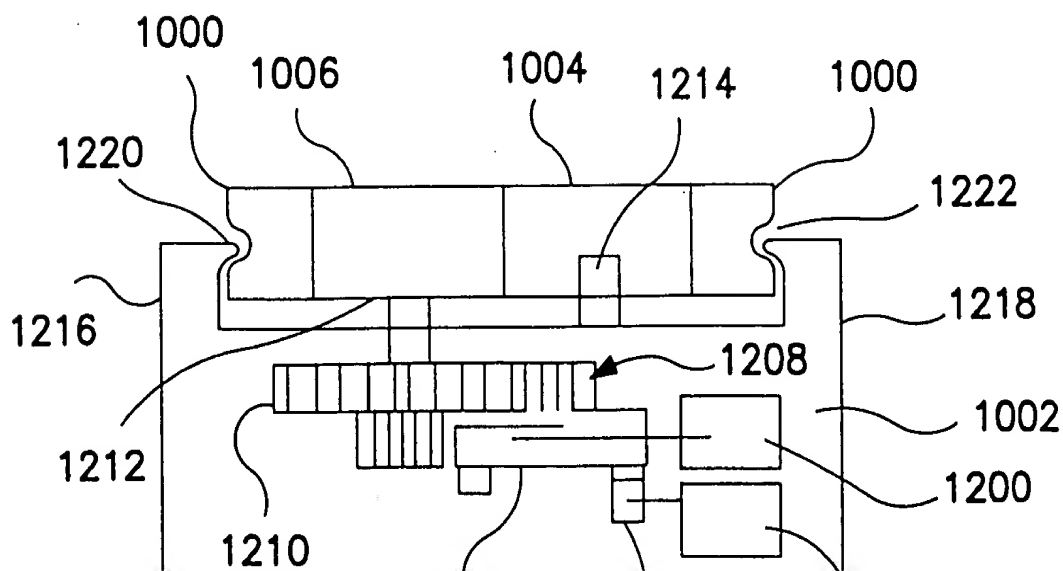
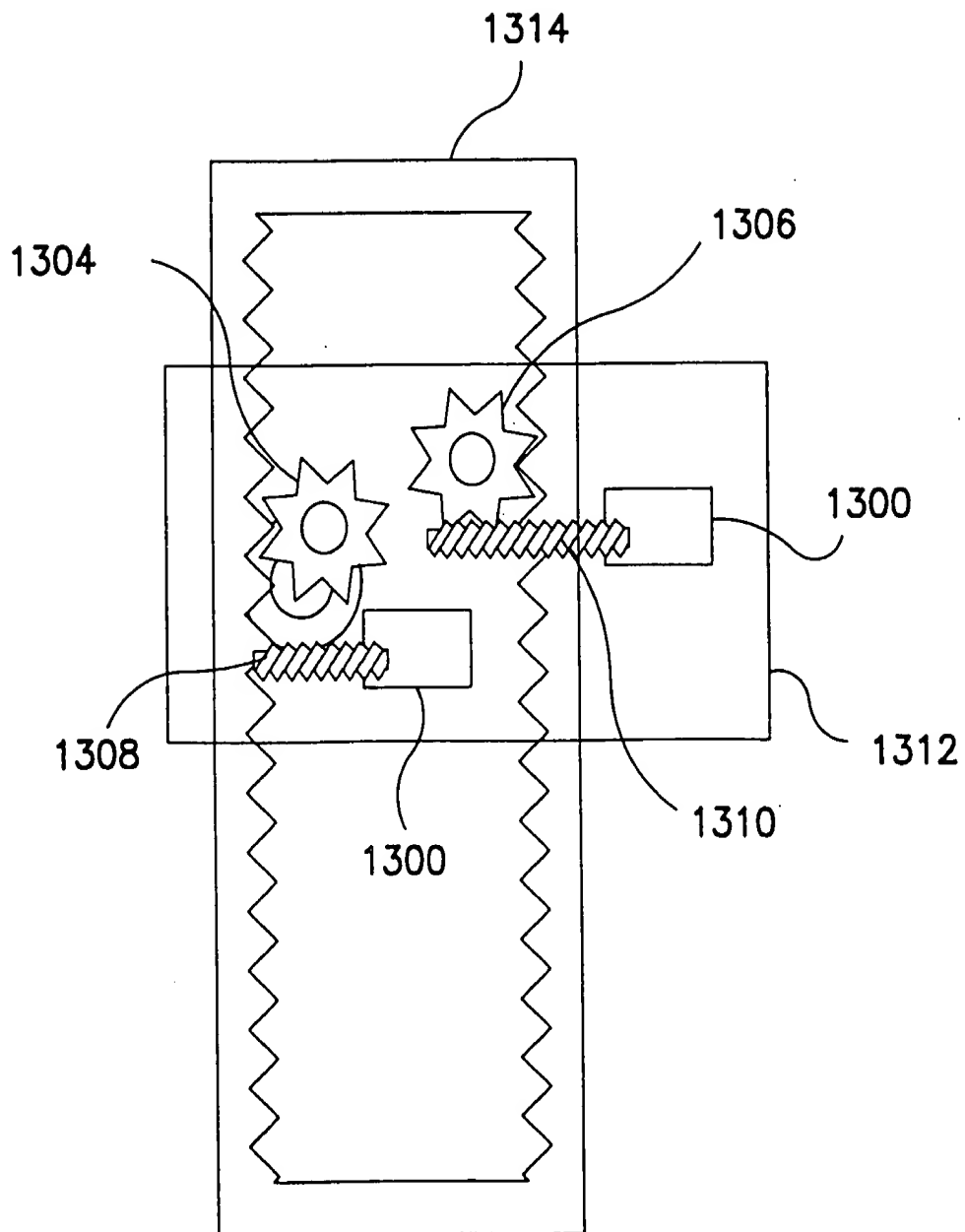


FIG. 13



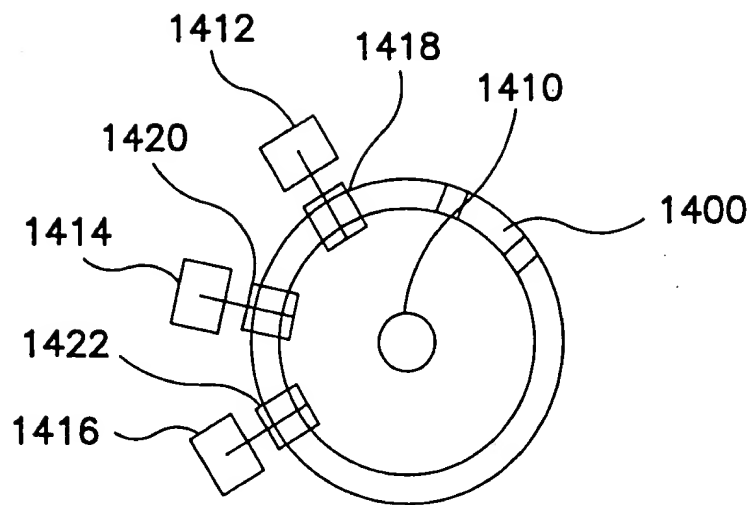


FIG. 14

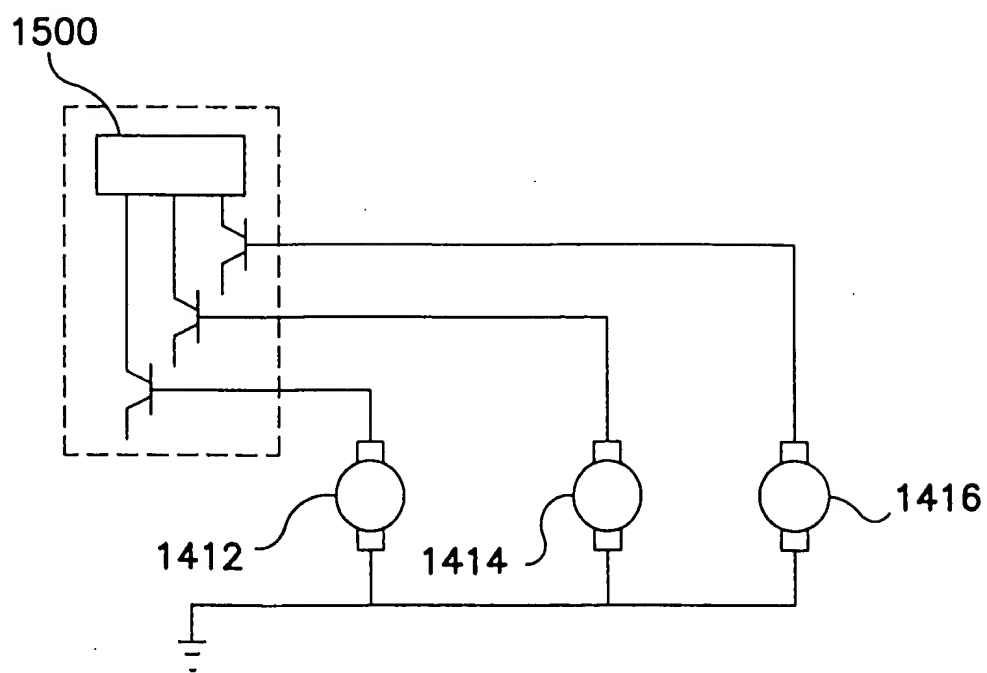


FIG. 15

FIG. 16 is a schematic diagram of a circular device 1600, such as a disk drive. The device includes a central hub 1610 and a circular track 1612. The track has a series of radial segments 1613, 1614, 1616, and 1618. A read/write head 1602 is positioned over the track, with a sensor 1604 and a control unit 1606. A spring 1608 is shown near the head. Other components labeled include 1620, 1622, 1624, and 1626.

A cross-sectional view of a semiconductor device. The structure includes a substrate 1600 with a central region 1602. On the left and right sides of the central region, there are structures 1604 and 1606, respectively. A layer 1618 is formed on the top surface of the central region 1602. A layer 1626 is formed on the top surface of the structures 1604 and 1606. The layer 1626 is thicker on the structures 1604 and 1606 than on the central region 1602.

FIG. 17

09765899-050701
FOI/050-66859260

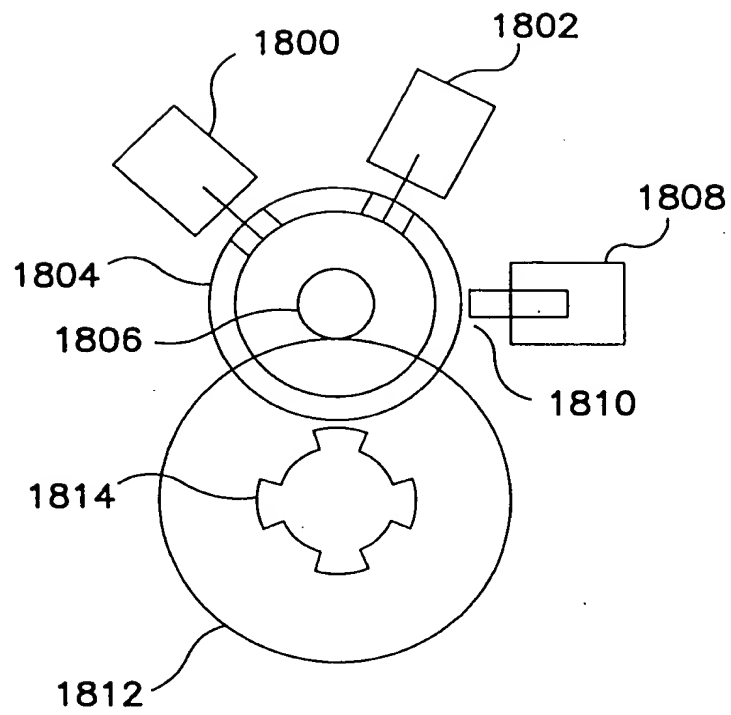


FIG. 18

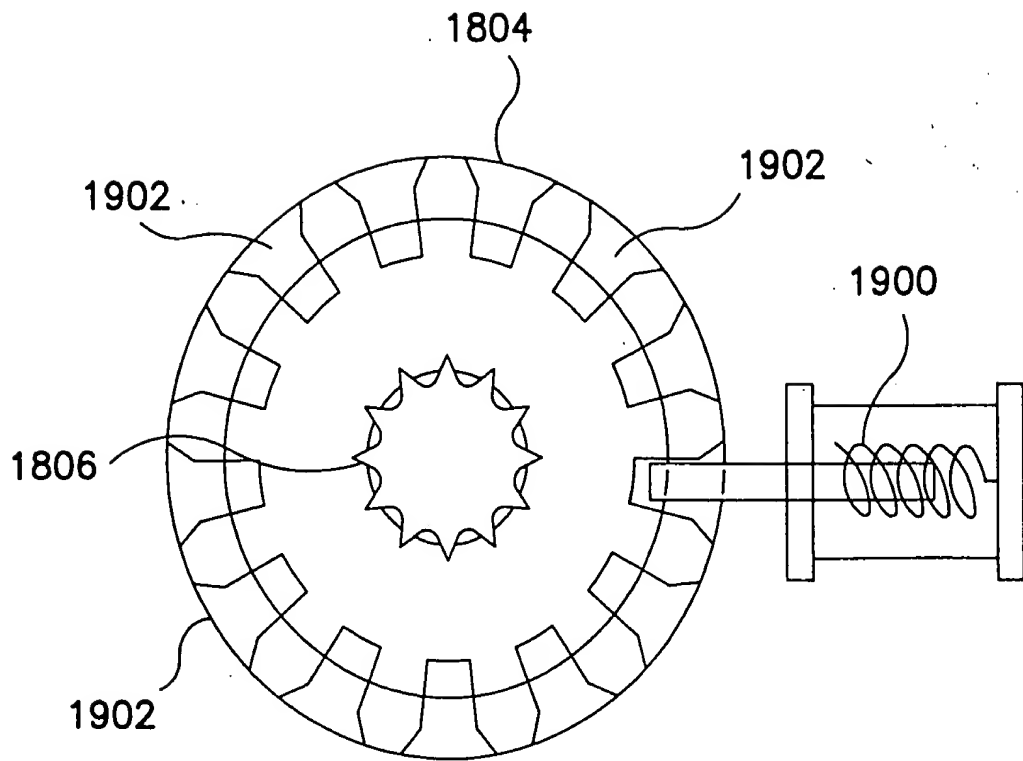


FIG. 19

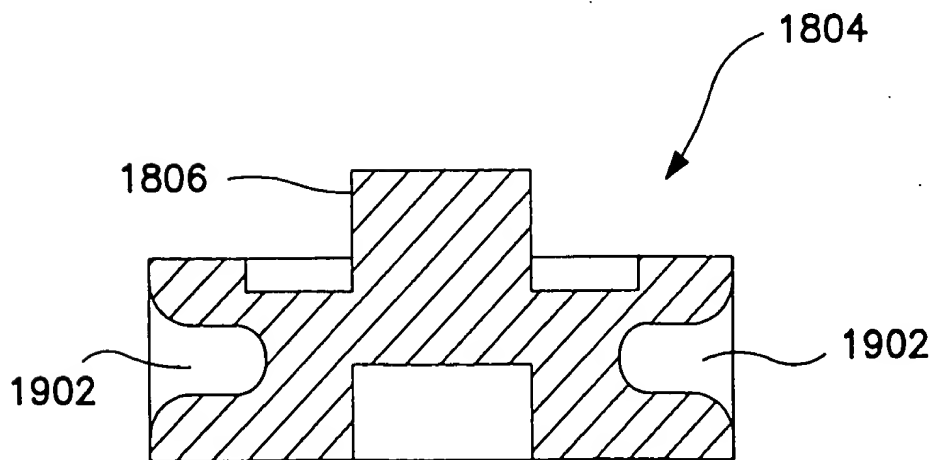
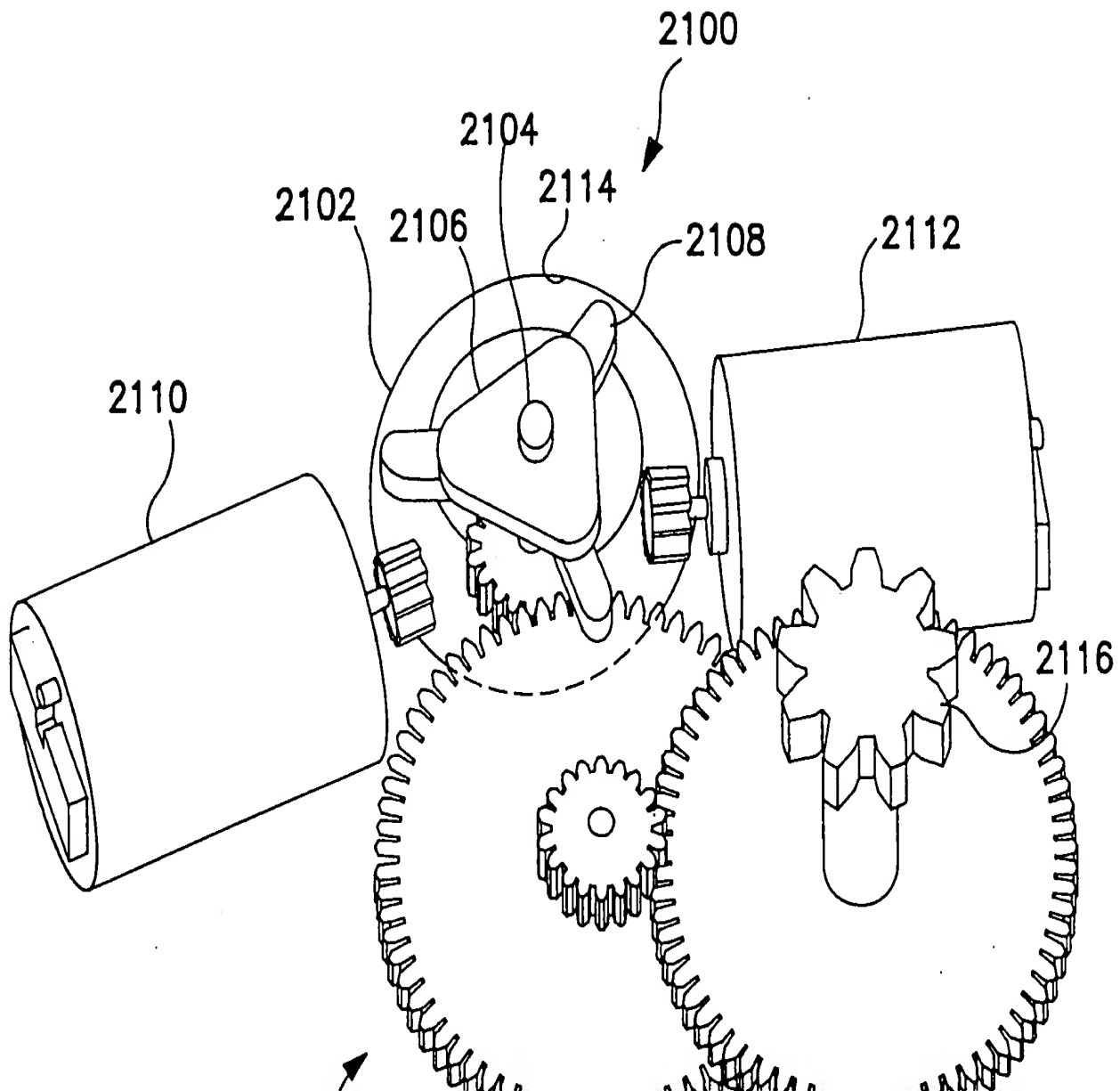


FIG. 20

FIG. 20 is a perspective view of the device 2000.



09765899.050701
10/050" 66859460

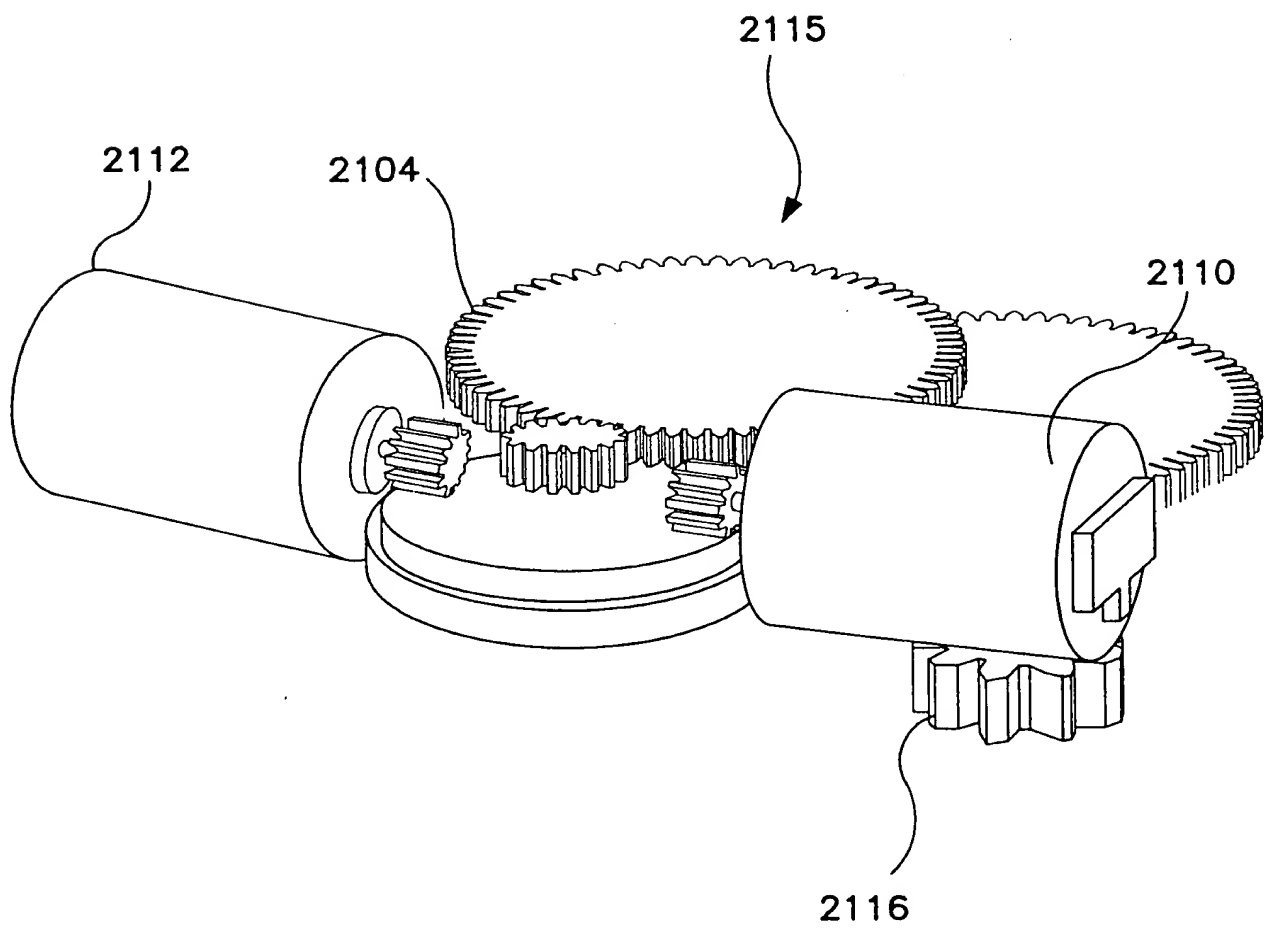


FIG. 22

FD2050" 66899260

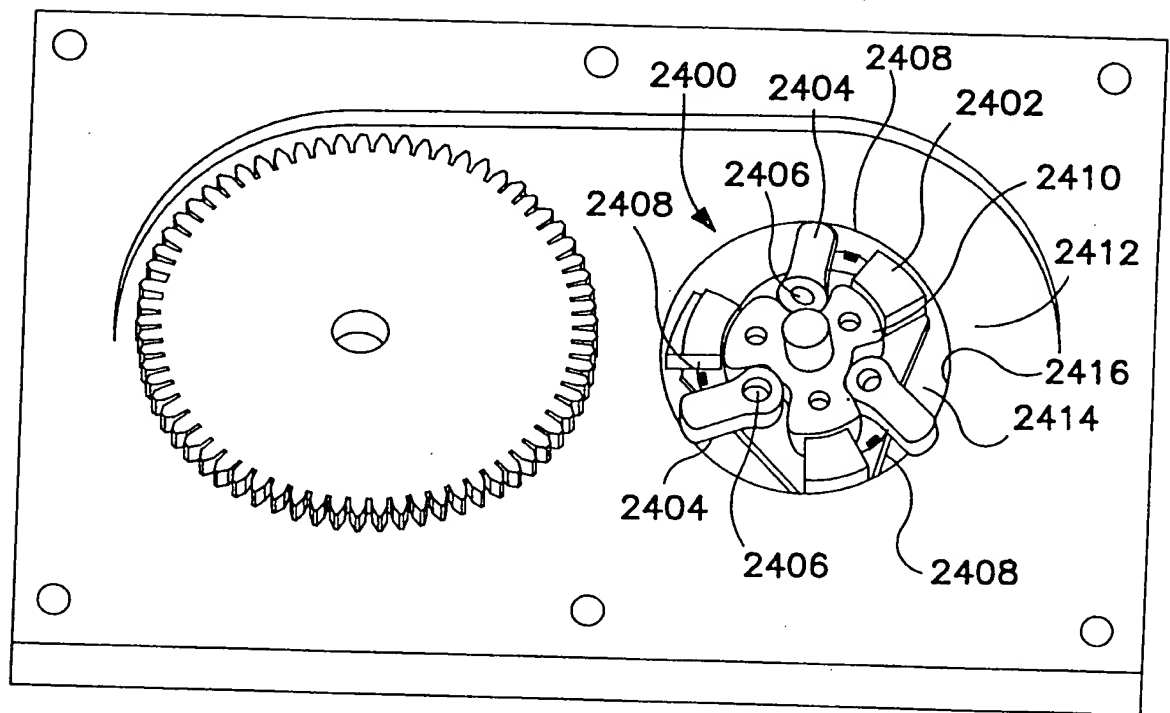


FIG. 24

09765899.050760

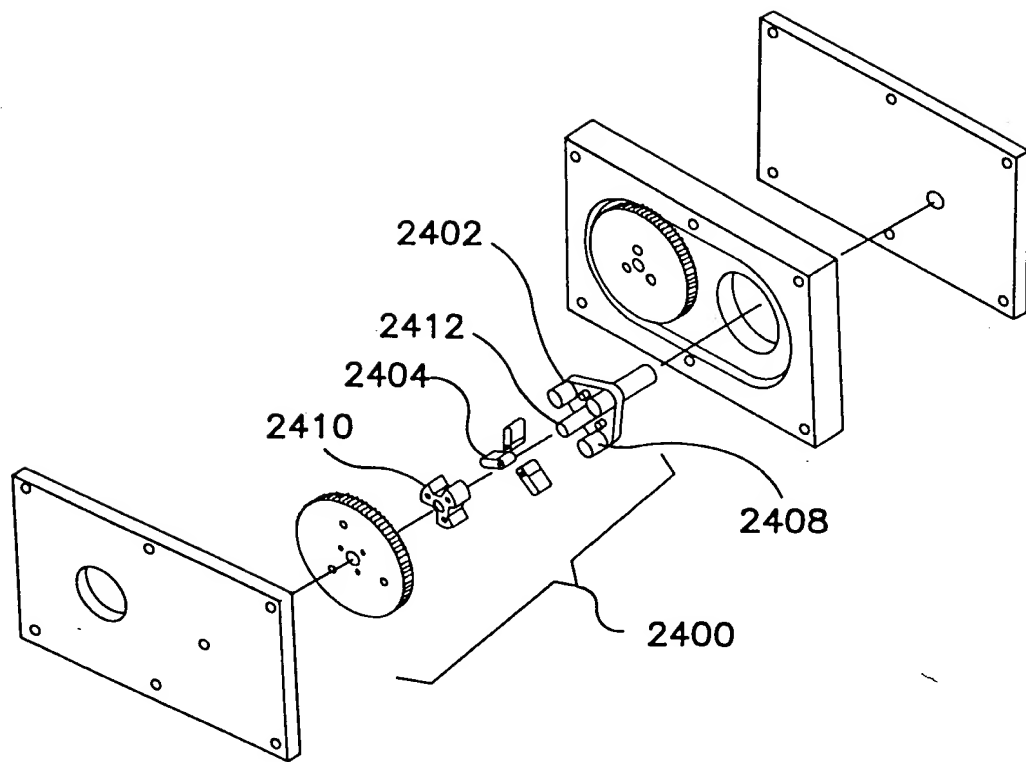


FIG. 25

702050" 66859260

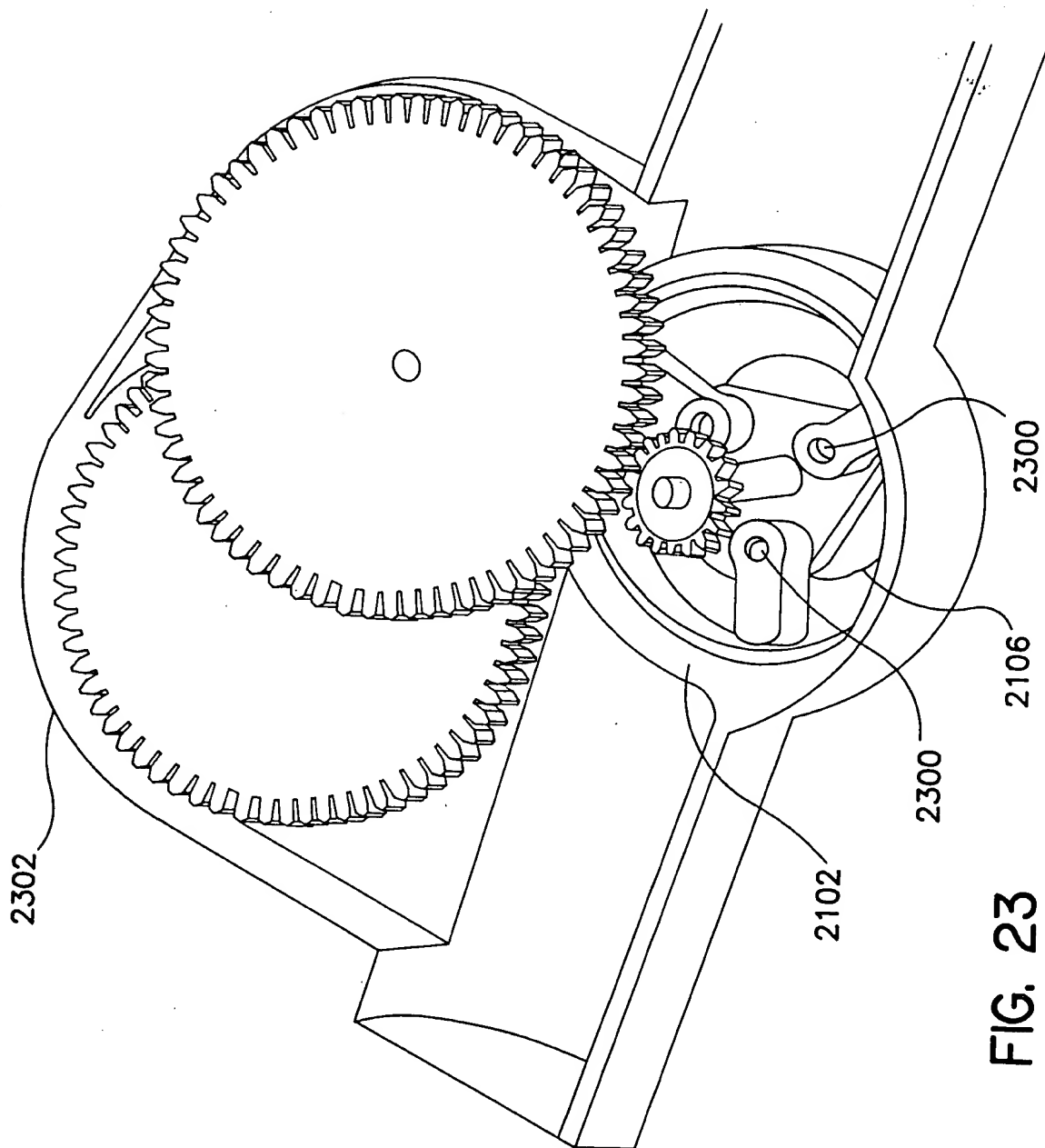


FIG. 23

09765899.050701
T04050" 66899260

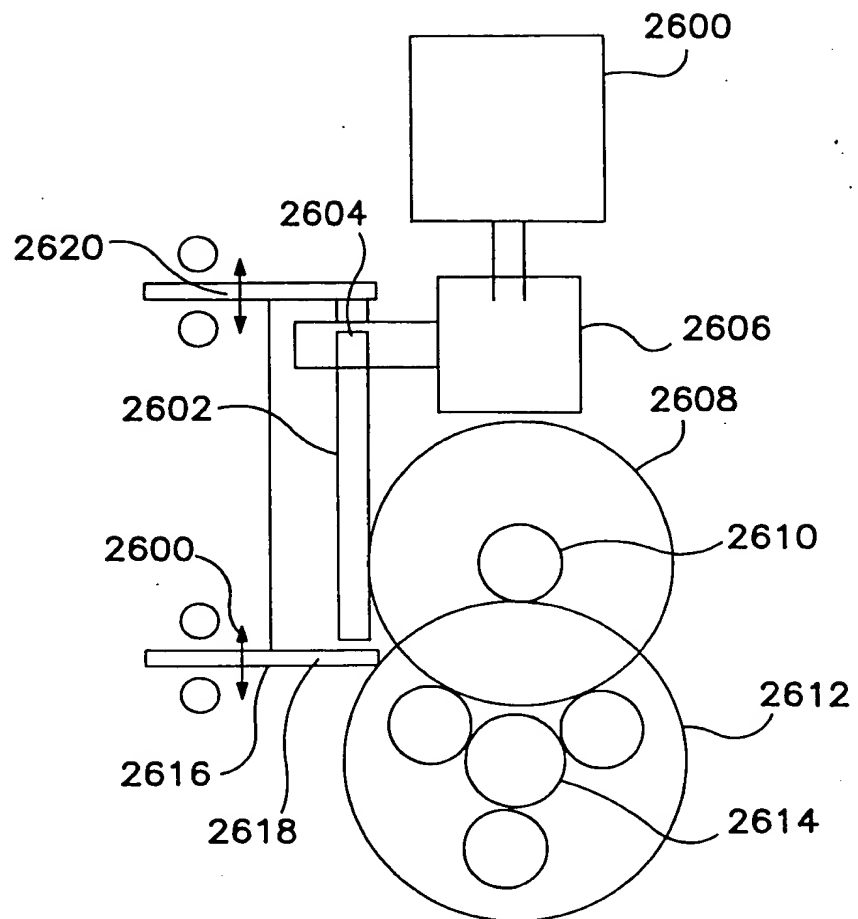


FIG. 26

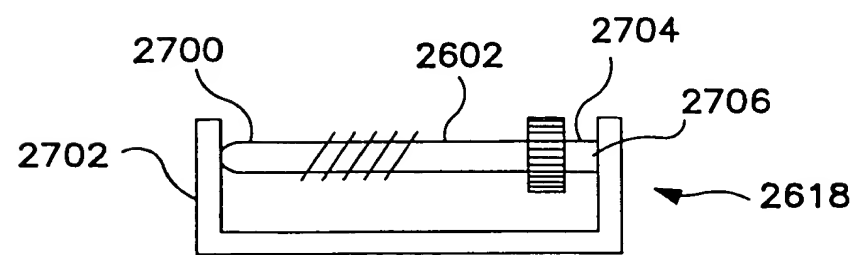


FIG. 27